



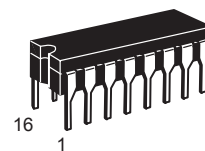
## 3-STATE HEX BUFFERS

These devices are high speed hex buffers with 3-state outputs. They are organized as single 6-bit or 2-bit/4-bit, with inverting or non-inverting data (D) paths. The outputs are designed to drive 15 TTL Unit Loads or 60 Low Power Schottky loads when the Enable (E) is LOW.

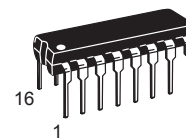
When the Output Enable (E) is HIGH, the outputs are forced to a high impedance "off" state. If the outputs of the 3-state devices are tied together, all but one device must be in the high impedance state to avoid high currents that would exceed the maximum ratings. Designers should ensure that Output Enable signals to 3-state devices whose outputs are tied together are designed so there is no overlap.

**SN54/74LS365A**  
**SN54/74LS366A**  
**SN54/74LS367A**  
**SN54/74LS368A**

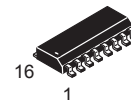
**3-STATE HEX BUFFERS**  
**LOW POWER SCHOTTKY**



**J SUFFIX**  
CERAMIC  
CASE 620-09



**N SUFFIX**  
PLASTIC  
CASE 648-08



**D SUFFIX**  
SOIC  
CASE 751B-03

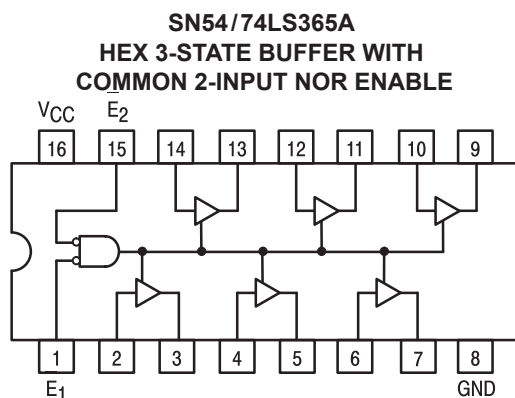
### ORDERING INFORMATION

SN54LSXXXJ Ceramic  
SN74LSXXXN Plastic  
SN74LSXXXD SOIC

### GUARANTEED OPERATING RANGES

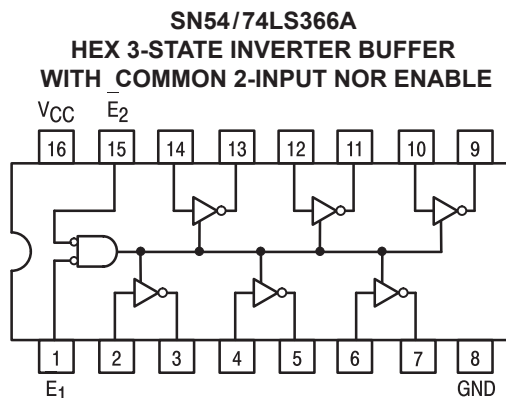
Symbol	Parameter		Min	Typ	Max	Unit
V <sub>CC</sub>	Supply Voltage	54 74	4.5 4.75	5.0 5.0	5.5 5.25	V
T <sub>A</sub>	Operating Ambient Temperature Range	54 74	-55 0	25 25	125 70	°C
I <sub>OH</sub>	Output Current — High	54 74			-1.0 -2.6	mA
I <sub>OL</sub>	Output Current — Low	54 74			12 24	mA

# **SN54/74LS365A • SN54/74LS366A** **SN54/74LS367A • SN54/74LS368A**



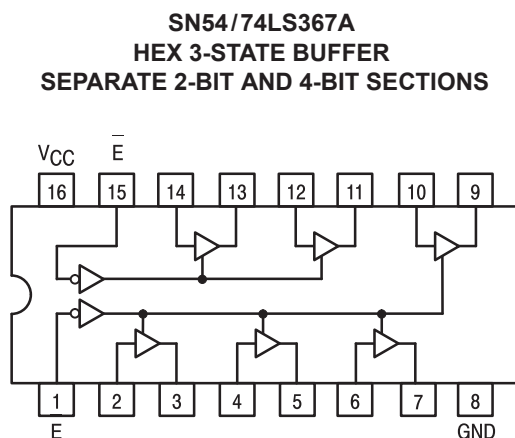
**TRUTH TABLE**

INPUTS			OUTPUT
$\overline{E_1}$	$\overline{E_2}$	D	
L	L	L	L
L	L	H	H
H	X	X	(Z)
X	H	X	(Z)



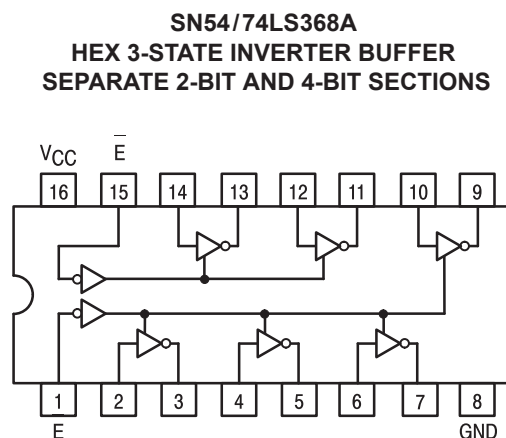
**TRUTH TABLE**

INPUTS			OUTPUT
$\overline{E_1}$	$\overline{E_2}$	D	
L	L	L	H
L	L	H	L
H	X	X	(Z)
X	H	X	(Z)



**TRUTH TABLE**

INPUTS		OUTPUT
$\overline{E}$	D	
L	L	L
L	H	H
H	X	(Z)



**TRUTH TABLE**

INPUTS		OUTPUT
$\overline{E}$	D	
L	L	H
L	H	L
H	X	(Z)

# SN54/74LS365A • SN54/74LS366A SN54/74LS367A • SN54/74LS368A

## DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

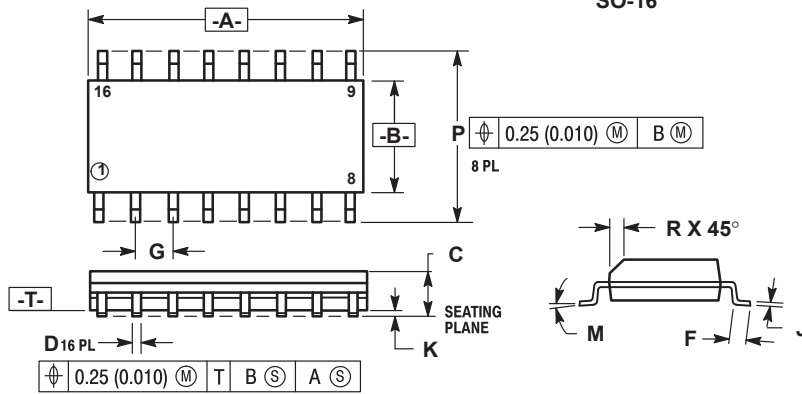
Symbol	Parameter		Limits			Unit	Test Conditions	
			Min	Typ	Max			
V <sub>IH</sub>	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V <sub>IL</sub>	Input LOW Voltage	54			0.7	V	Guaranteed Input LOW Voltage for All Inputs	
		74			0.8			
V <sub>IK</sub>	Input Clamp Diode Voltage			−0.65	−1.5	V	V <sub>CC</sub> = MIN, I <sub>IN</sub> = −18 mA	
V <sub>OH</sub>	Output HIGH Voltage	54	2.4	3.4		V	V <sub>CC</sub> = MIN, I <sub>OH</sub> = MAX, V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> per Truth Table	
		74	2.4	3.1		V		
V <sub>OL</sub>	Output LOW Voltage	54, 74		0.25	0.4	V	I <sub>OL</sub> = 12 mA	V <sub>CC</sub> = V <sub>CC</sub> MIN, V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> per Truth Table
		74		0.35	0.5	V	I <sub>OL</sub> = 24 mA	
I <sub>OZH</sub>	Output Off Current HIGH				20	μA	V <sub>CC</sub> = MAX, V <sub>OUT</sub> = 2.7 V	
I <sub>OZL</sub>	Output Off Current LOW				−20	μA	V <sub>CC</sub> = MAX, V <sub>OUT</sub> = 0.4 V	
I <sub>IH</sub>	Input HIGH Current				20	μA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 2.7 V	
					0.1	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 7.0 V	
I <sub>IL</sub>	Input LOW Current E Inputs				−0.4	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 0.4 V	
	D Inputs				−20	μA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 0.5 V Either E Input at 2.0 V	
					−0.4	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 0.4 V Both E Inputs at 0.4 V	
I <sub>OS</sub>	Short Circuit Current (Note 1)		−40		−225	mA	V <sub>CC</sub> = MAX	
I <sub>CC</sub>	Power Supply Current LS365A, 367A				24	mA	V <sub>CC</sub> = MAX	
	LS366A, 368A				21			

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

## AC CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ , $V_{CC} = 5.0 \text{ V}$ )

Symbol	Parameter	Limits						Unit	Test Conditions
		LS365A/LS367A			LS366A/LS368A				
		Min	Typ	Max	Min	Typ	Max		
tPLH tPHL	Propagation Delay		10 9.0	16 22		7.0 12	15 18	ns	C <sub>L</sub> = 45 pF, R <sub>L</sub> = 667 Ω
tPZH tPZL	Output Enable Time		19 24	35 40		18 28	35 45	ns	
tPHZ tPLZ	Output Disable Time			30 35			32 35	ns	C <sub>L</sub> = 5.0 pF

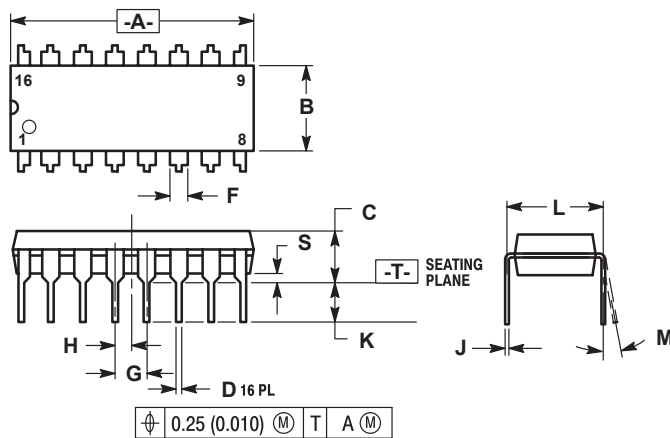
**Case 751B-03 D Suffix**  
**16-Pin Plastic**  
**SO-16**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: MILLIMETER.
  3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  5. 751B-01 IS OBSOLETE, NEW STANDARD 751B-03.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

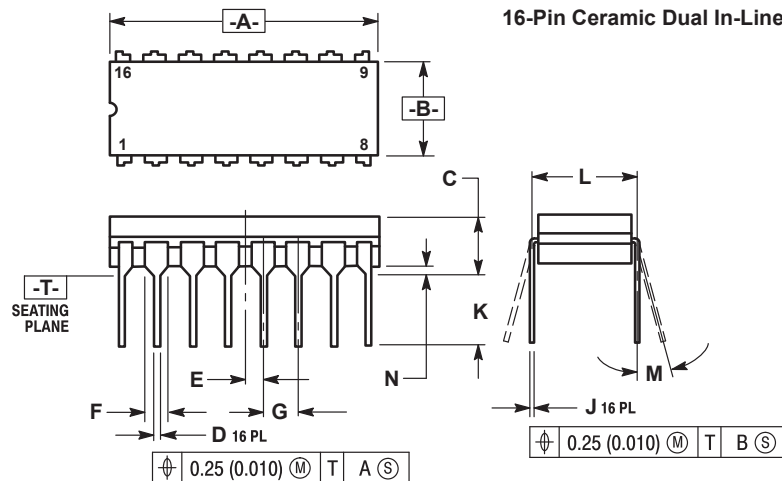
**Case 648-08 N Suffix**  
**16-Pin Plastic**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.
  6. 648-01 THRU -07 OBSOLETE, NEW STANDARD 648-08.


DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	18.80	19.55	0.740	0.770
B	6.35	6.85	0.250	0.270
C	3.69	4.44	0.145	0.175
D	0.39	0.53	0.015	0.021
F	1.02	1.77	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	1.27 BSC		0.050 BSC	
J	0.21	0.38	0.008	0.015
K	2.80	3.30	0.110	0.130
L	7.50	7.74	0.295	0.305
M	0°	10°	0°	10°
S	0.51	1.01	0.020	0.040

**Case 620-09 J Suffix**  
**16-Pin Ceramic Dual In-Line**



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIM F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.
  5. 620-01 THRU -08 OBSOLETE, NEW STANDARD 620-09.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	19.05	19.55	0.750	0.770
B	6.10	7.36	0.240	0.290
C	—	4.19	—	0.165
D	0.39	0.53	0.015	0.021
E	1.27 BSC		0.050 BSC	
F	1.40	1.77	0.055	0.070
G	2.54 BSC		0.100 BSC	
J	0.23	0.27	0.009	0.011
K	—	5.08	—	0.200
L	7.62 BSC		0.300 BSC	
M	0°	15°	0°	15°
N	0.39	0.88	0.015	0.035

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